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Details

Product Status	Obsolete
Core Processor	M16C/60
Core Size	16-Bit
Speed	20MHz
Connectivity	CANbus, I ² C, IEBus, SIO, UART/USART
Peripherals	DMA, POR, PWM, Voltage Detect, WDT
Number of I/O	55
Program Memory Size	96KB (96K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 16x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	64-LFQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/m30291fahp-u7a

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Quick Reference to Pages Classified by Address

Address	Register	Symbol	Page
0180 ₁₆			
0181 ₁₆			
0182 ₁₆			
0183 ₁₆			
0184 ₁₆			
0185 ₁₆			
0186 ₁₆			
01B0 ₁₆			
01B1 ₁₆			
01B2 ₁₆			
01B3 ₁₆	Flash memory control register 4 (Note 2)	FMR4	342
01B4 ₁₆			
01B5 ₁₆	Flash memory control register 1 (Note 2)	FMR1	341
01B6 ₁₆			
01B7 ₁₆	Flash memory control register 0 (Note 2)	FMR0	341
01B8 ₁₆			
01B9 ₁₆			
01BA ₁₆			
01BB ₁₆			
01BC ₁₆			
0200 ₁₆	CAN0 message control register 0	C0MCTL0	292
0201 ₁₆	CAN0 message control register 1	C0MCTL1	292
0202 ₁₆	CAN0 message control register 2	C0MCTL2	292
0203 ₁₆	CAN0 message control register 3	C0MCTL3	292
0204 ₁₆	CAN0 message control register 4	C0MCTL4	292
0205 ₁₆	CAN0 message control register 5	C0MCTL5	292
0206 ₁₆	CAN0 message control register 6	C0MCTL6	292
0207 ₁₆	CAN0 message control register 7	C0MCTL7	292
0208 ₁₆	CAN0 message control register 8	C0MCTL8	292
0209 ₁₆	CAN0 message control register 9	C0MCTL9	292
020A ₁₆	CAN0 message control register 10	C0MCTL10	292
020B ₁₆	CAN0 message control register 11	C0MCTL11	292
020C ₁₆	CAN0 message control register 12	C0MCTL12	292
020D ₁₆	CAN0 message control register 13	C0MCTL13	292
020E ₁₆	CAN0 message control register 14	C0MCTL14	292
020F ₁₆	CAN0 message control register 15	C0MCTL15	292
0210 ₁₆			
0211 ₁₆	CAN0 control register	C0CTLR	293
0212 ₁₆			
0213 ₁₆	CAN0 status register	C0STR	294
0214 ₁₆			
0215 ₁₆	CAN0 slot status register	C0SSTR	295
0216 ₁₆			
0217 ₁₆	CAN 0 interrupt control register	C0ICR	296
0218 ₁₆			
0219 ₁₆	CAN0 extended ID register	C0IDR	296
021A ₁₆			
021B ₁₆	CAN0 configuration register	C0CONR	297
021C ₁₆	CAN0 receive error count register	C0RECR	298
021D ₁₆	CAN0 transmit error count register	C0TECR	298
021E ₁₆			
021F ₁₆	CAN0 time stamp register	C0TSR	299
0210 ₁₆			
02FE ₁₆			
02FF ₁₆			

Note 1: The blank areas are reserved and cannot be accessed by users.

Note 2: This register is included in the flash memory version.

[illegible]

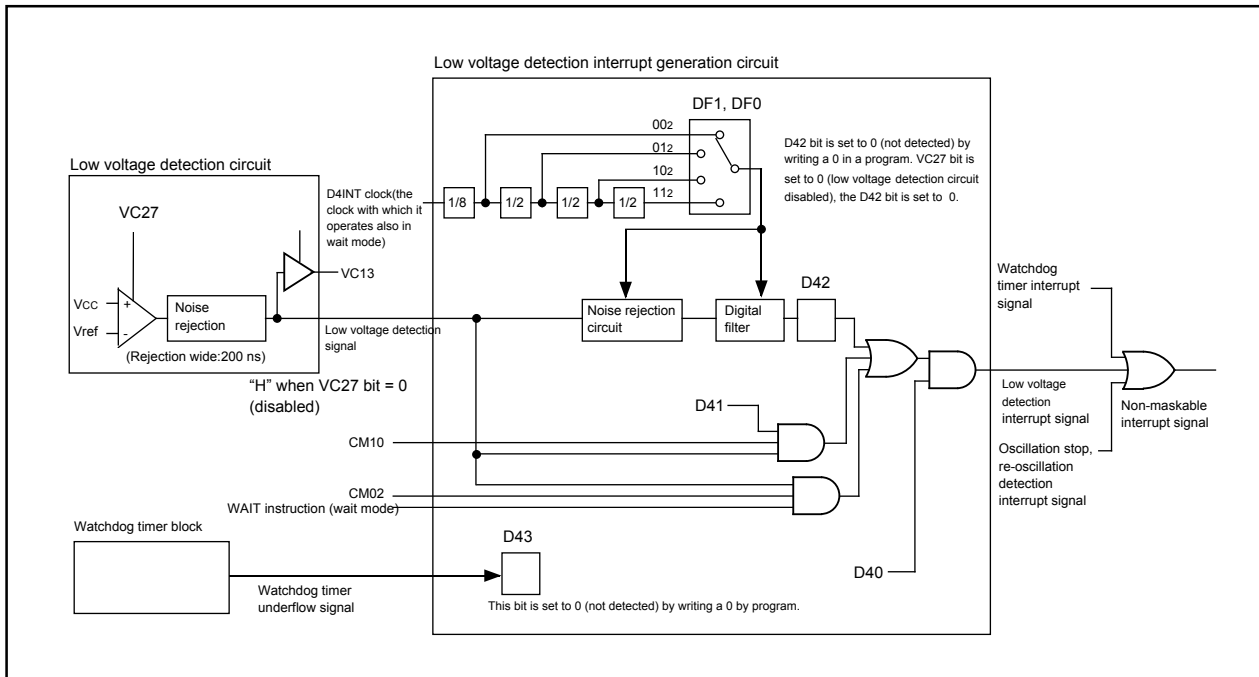


Figure 5.8 Low Voltage Detection Interrupt Generation Block

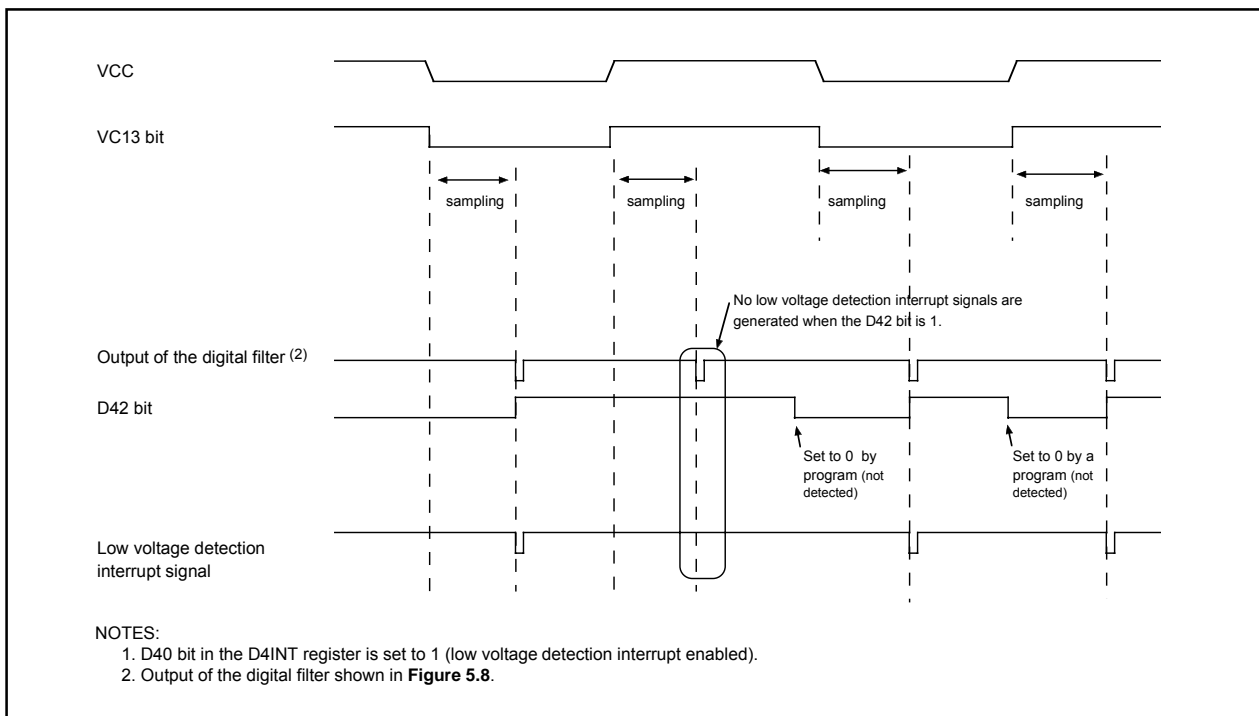
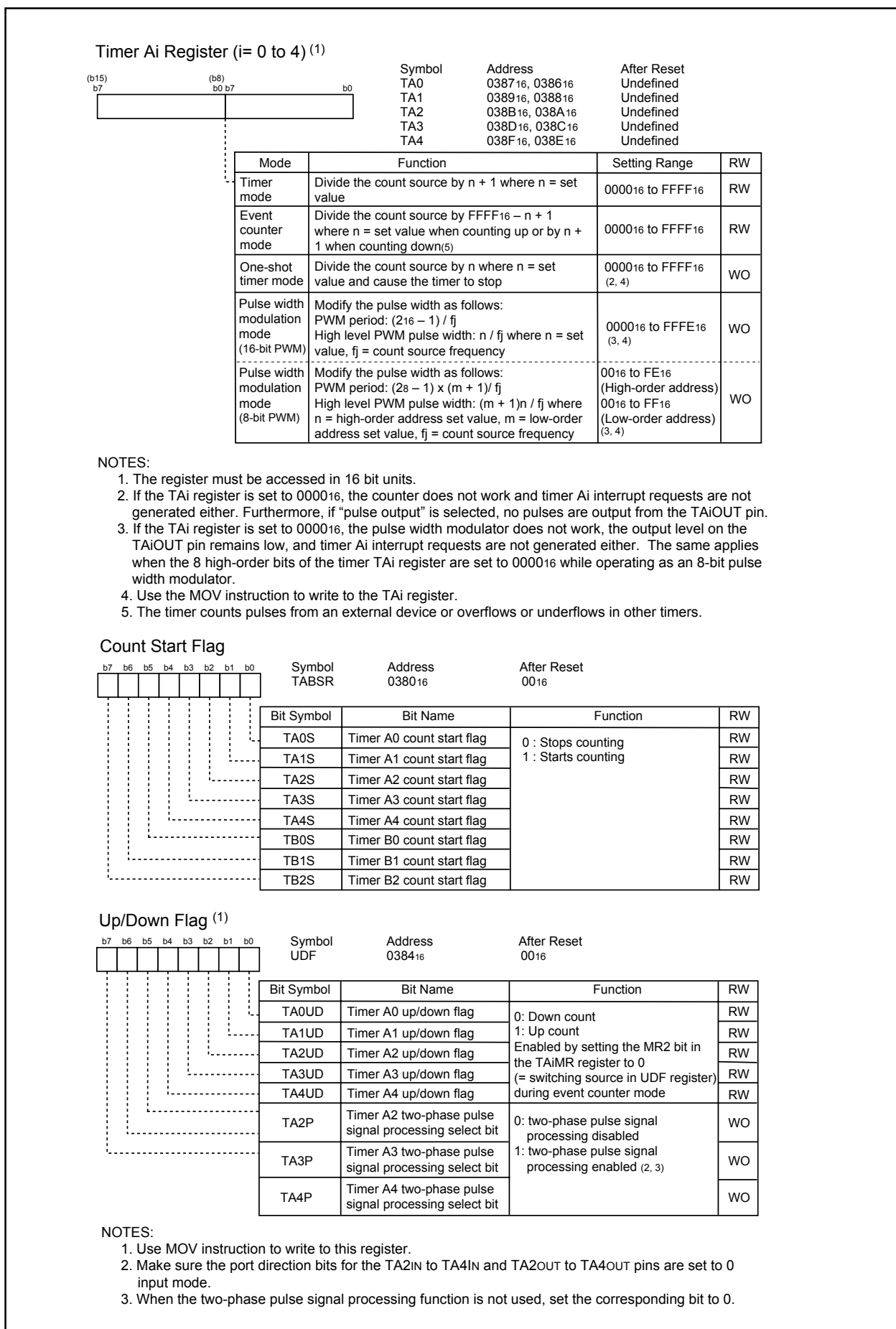


Figure 5.9 Low voltage Detection Interrupt Generation Circuit Operation Example



Interrupt Request Register (1)

<div><div>b7b6b5b4b3b2b1b0</div><div></div></div>								Symbol G1IR	Address 0330 ₁₆	After Reset Undefined

NOTE:

- When writing 0 to each bit in the G1IR register, use the following instruction:
AND, BCLR

Figure 13.9 G1IR Register

14.1.3.1 Detection of Start and Stop Condition

Whether a start or a stop condition has been detected is determined.

A start condition-detected interrupt request is generated when the SDA2 pin changes state from high to low while the SCL2 pin is in the high state. A stop condition-detected interrupt request is generated when the SDA2 pin changes state from low to high while the SCL2 pin is in the high state.

Because the start and stop condition-detected interrupts share the interrupt control register and vector, check the BBS bit in the U2SMR register to determine which interrupt source is requesting the interrupt.

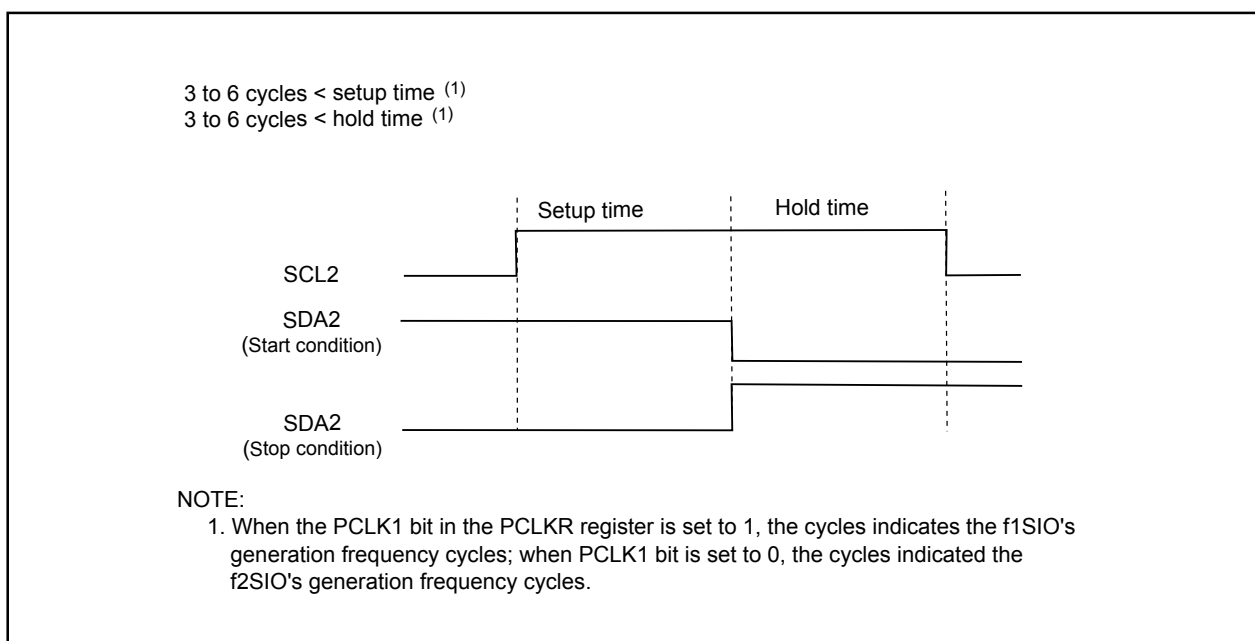


Figure 14.24 Detection of Start and Stop Condition

14.1.3.2 Output of Start and Stop Condition

A start condition is generated by setting the STAREQ bit in the U2SMR4 register to 1 (start).

A restart condition is generated by setting the RSTAREQ bit in the U2SMR4 register to 1 (start).

A stop condition is generated by setting the STPREQ bit in the U2SMR4 register to 1 (start).

The output procedure is described below.

(1) Set the STAREQ bit, RSTAREQ bit or STPREQ bit to 1 (start).

(2) Set the STSPSEL bit in the U2SMR4 register to 1 (output).

Make sure that no interrupts or DMA transfers will occur between (1) and (2).

The function of the STSPSEL bit is shown in **Table 14.14** and **Figure 14.25**.

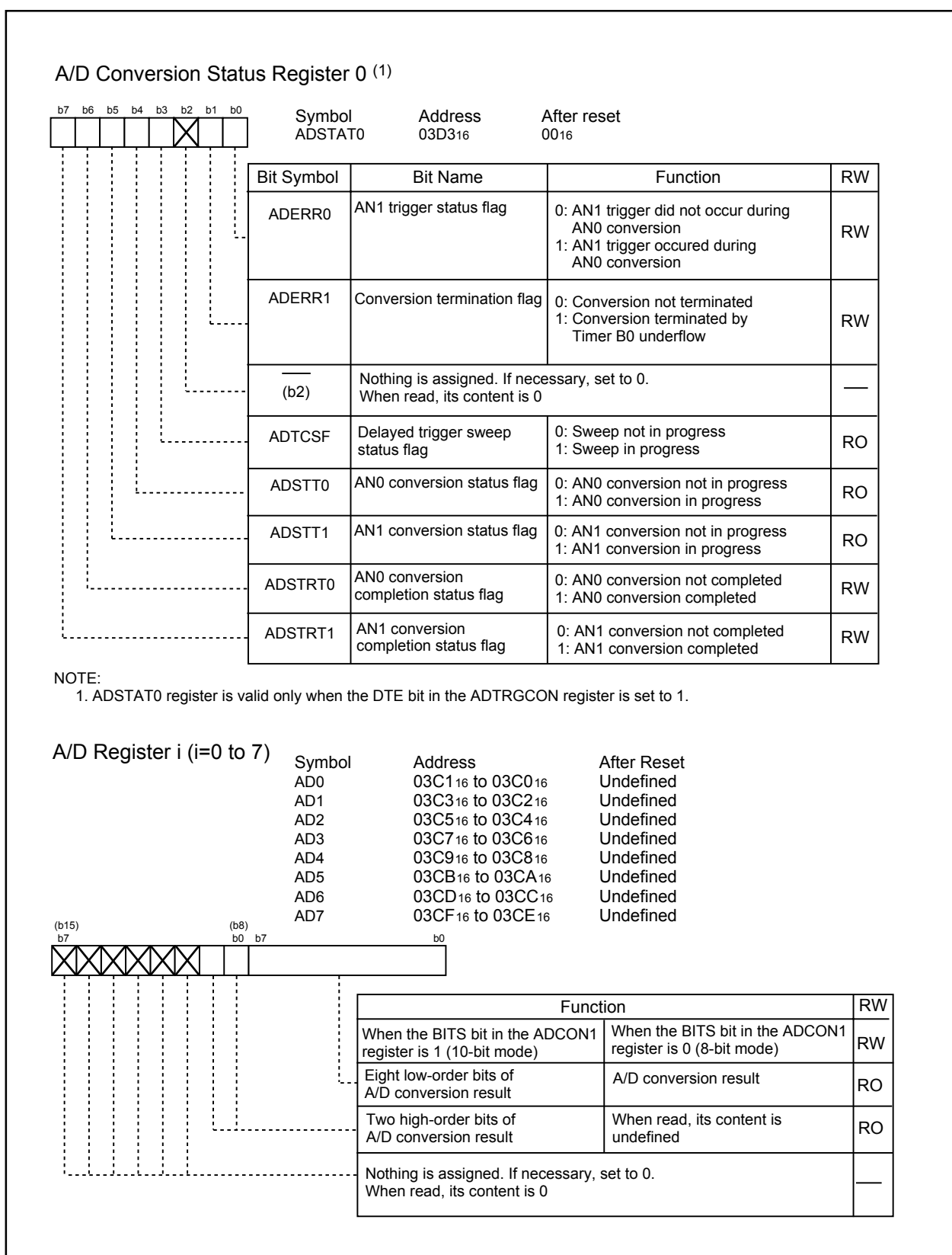


Figure 15.4 ADSTAT0 Register and AD0 to AD7 Registers

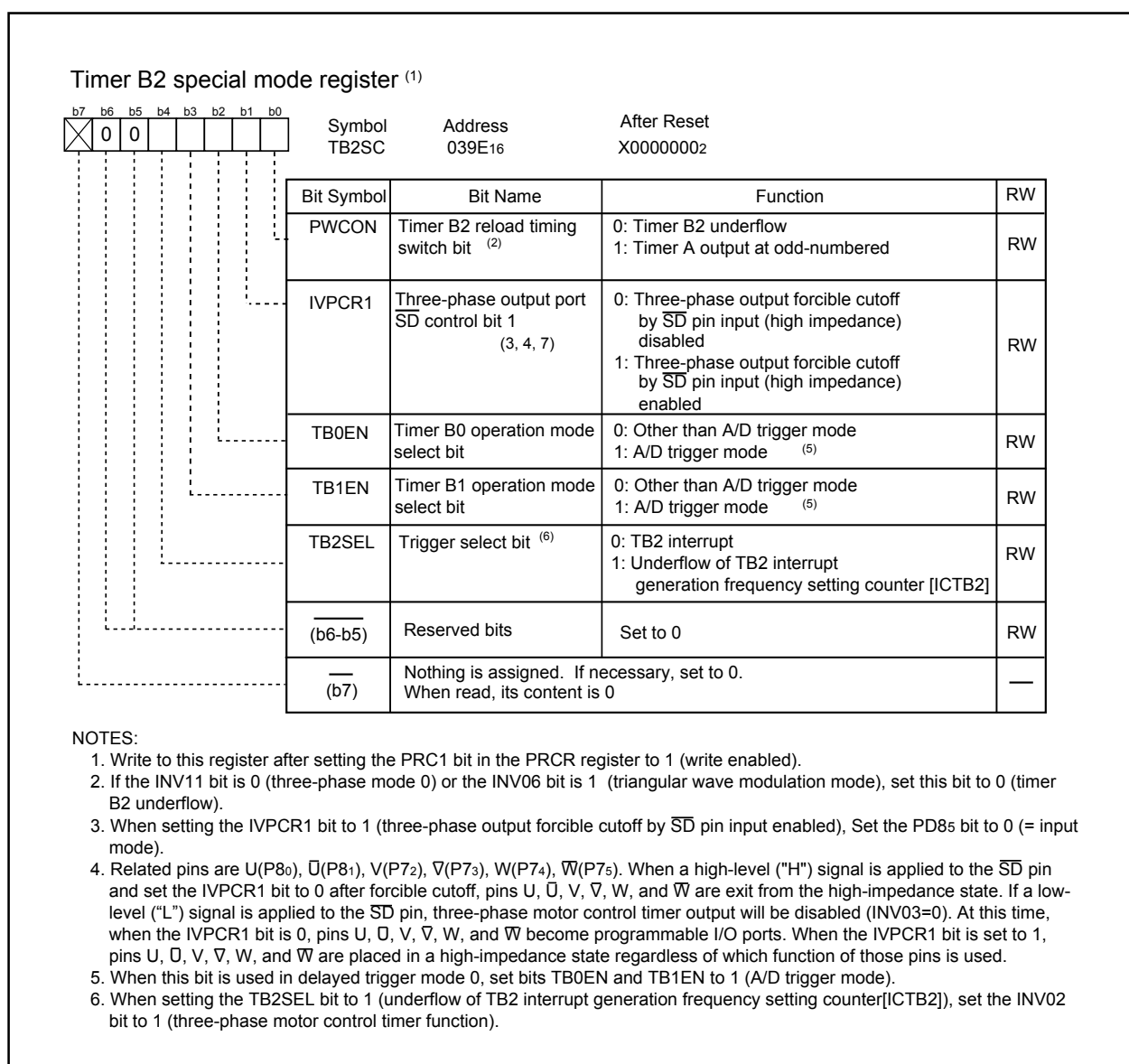


Figure 15.5 TB2SC Register

17.1.1 CAN0 Message Box

Table 17.1 shows the memory mapping of the CAN0 message box.

It is possible to access to the message box in byte or word.

Mapping of the message contents differs from byte access to word access. Byte access or word access can be selected by the MsgOrder bit of the C0CTLR register.

Table 17.1 Memory Mapping of CAN0 Message Box

Address	Message content (Memory mapping)	
	Byte access (8 bits)	Word access (16 bits)
$0060_{16} + n \cdot 16 + 0$	SID ₁₀ to SID ₆	SID ₅ to SID ₀
$0060_{16} + n \cdot 16 + 1$	SID ₅ to SID ₀	SID ₁₀ to SID ₆
$0060_{16} + n \cdot 16 + 2$	EID ₁₇ to EID ₁₄	EID ₁₃ to EID ₆
$0060_{16} + n \cdot 16 + 3$	EID ₁₃ to EID ₆	EID ₁₇ to EID ₁₄
$0060_{16} + n \cdot 16 + 4$	EID ₅ to EID ₀	Data Length Code (DLC)
$0060_{16} + n \cdot 16 + 5$	Data Length Code (DLC)	EID ₅ to EID ₀
$0060_{16} + n \cdot 16 + 6$	Data byte 0	Data byte 1
$0060_{16} + n \cdot 16 + 7$	Data byte 1	Data byte 0
\vdots	\vdots	\vdots
$0060_{16} + n \cdot 16 + 13$	Data byte 7	Data byte 6
$0060_{16} + n \cdot 16 + 14$	Time stamp high-order byte	Time stamp low-order byte
$0060_{16} + n \cdot 16 + 15$	Time stamp low-order byte	Time stamp high-order byte

n = 0 to 15: the number of the slot

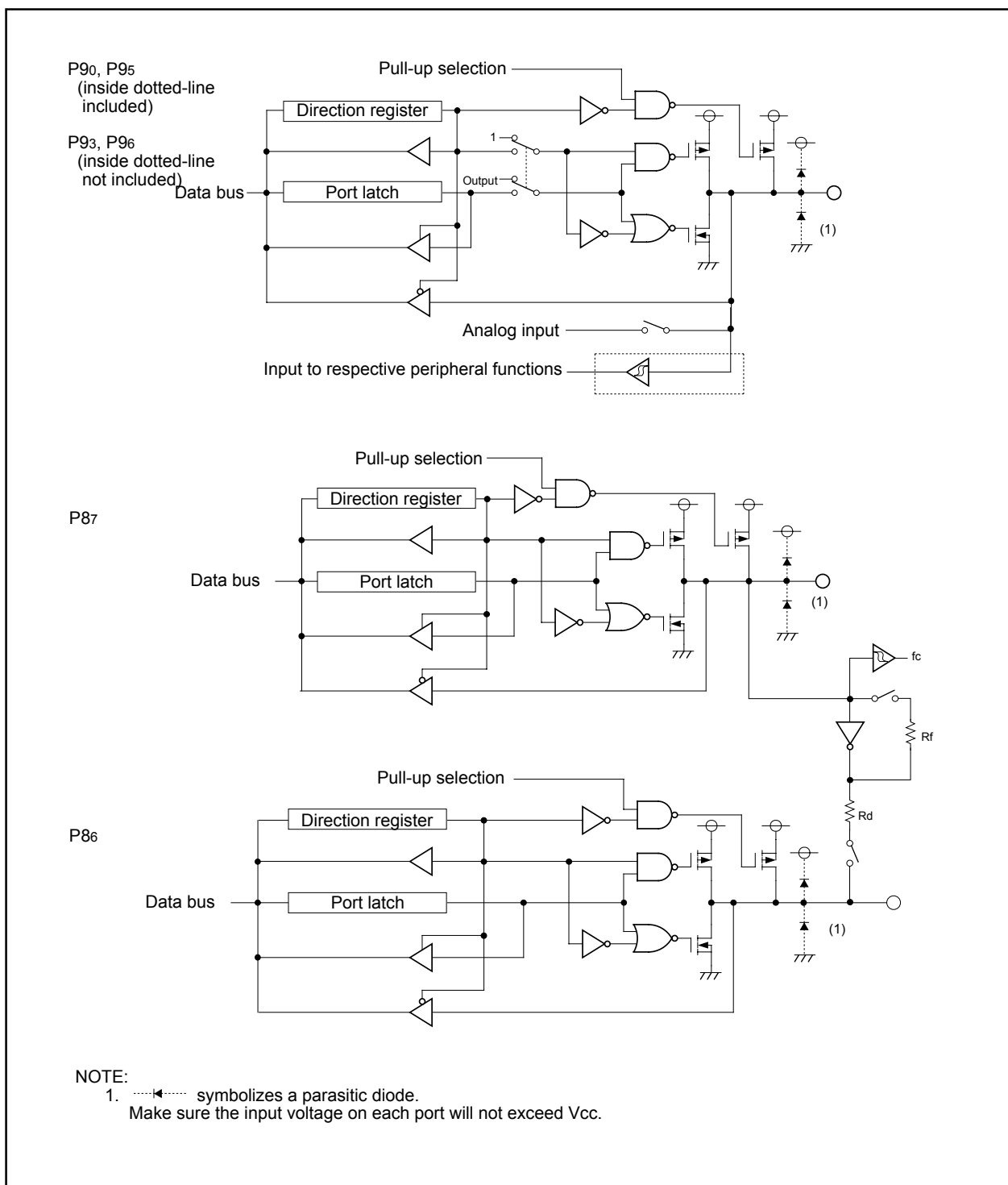


Figure 19.4 I/O Ports (4)

20.2 Memory Map

The flash memory contains the user ROM area and the boot ROM area (reserved area). **Figures 20.1 to 20.3** show a block diagram of the flash memory. The user ROM area has space to store the MCU operation program in single-chip mode and two 2-Kbyte spaces: the block A and B.

The user ROM area is divided into several blocks. The user ROM area can be rewritten in CPU rewrite, standard serial I/O, parallel I/O, or CAN I/O mode.

However, to rewrite program in block 0 and 1 in CPU rewrite mode, set the FMR02 bit in the FMR0 register to 1 (block 0, 1 rewrite enabled) and the FMR16 bit in the FMR1 register to 1 (blocks 0 to 5 rewrite enabled). Also, to rewrite program in blocks 2 to 5 in CPU rewrite mode, set the FMR16 bit in the FMR1 register to 1 (blocks 0 to 5 rewrite enabled). When the PM10 bit in the PM1 register is set to 1 (data space access enabled), blocks A and B can be available for use.

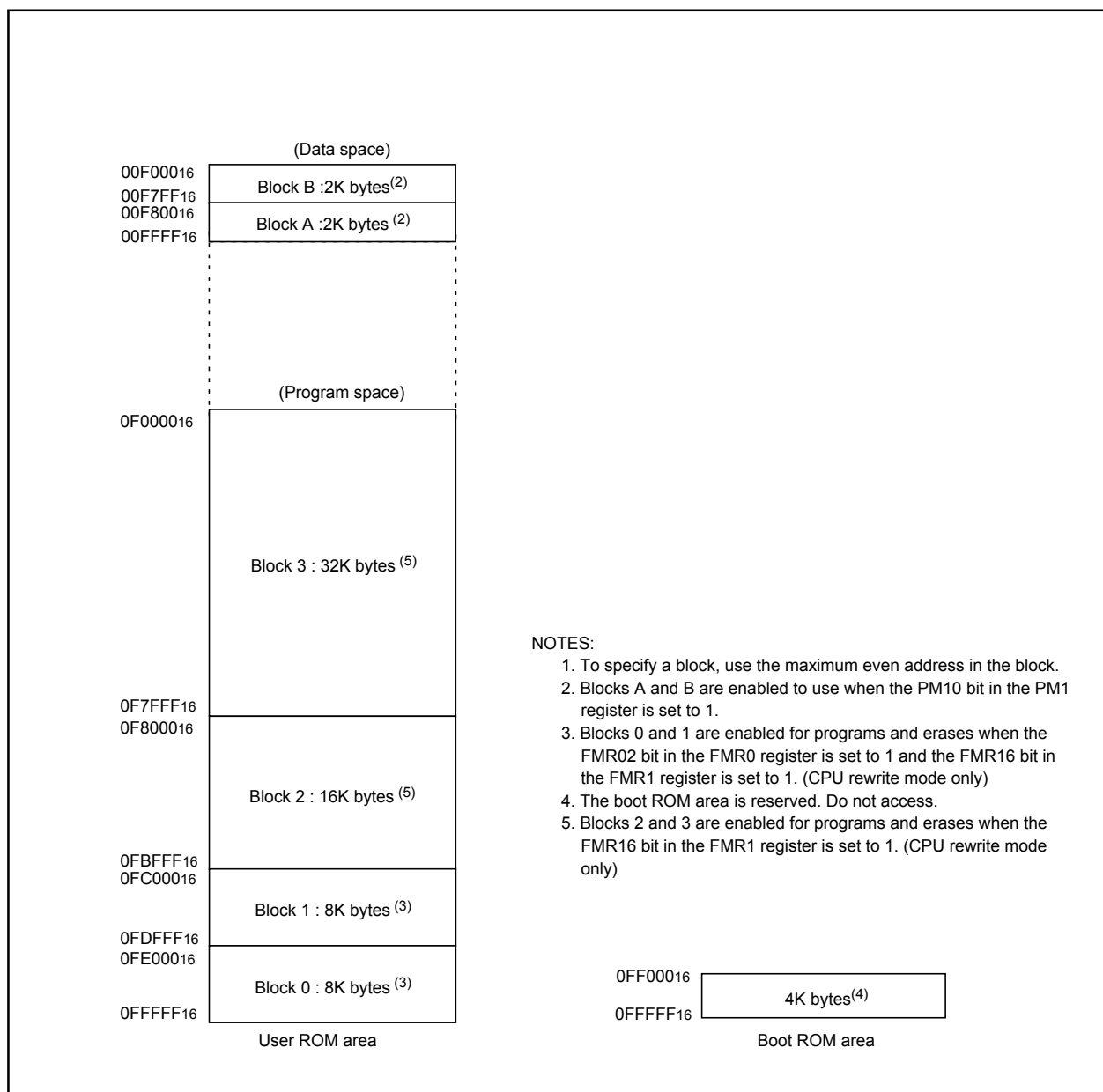


Figure 20.1 Flash Memory Block Diagram (ROM capacity 64 Kbytes)

20.8.4 Full Status Check

If an error occurs, bits FMR06 to FMR07 in the FMR0 register are set to 1, indicating a specific error. Therefore, execution results can be confirmed by verifying these status bits (full status check).

Table 20.7 lists errors and FMR0 register state. **Figure 20.14** shows a flow chart of the full status check and handling procedure for each error.

Table 20.7 Errors and FMR0 Register Status

FMR0 register (SRD register) status		Error	Error occurrence condition
FMR07 (SR5)	FMR06 (SR4)		
1	1	Command sequence error	<ul style="list-style-type: none"> • An incorrect commands is written • A value other than <code>xxD0₁₆</code> or <code>xxFF₁₆</code> is written in the second bus cycle of the block erase command ⁽¹⁾ • When the block erase command is executed on an protected block • When the program command is executed on protected blocks
1	0	Erase error	<ul style="list-style-type: none"> • The block erase command is executed on an unprotected block but the program operation is not successfully completed
0	1	Program error	<ul style="list-style-type: none"> • The program command is executed on an unprotected block but the program operation is not successfully completed

Note 1: The flash memory enters read array mode by writing command code `xxFF16` in the second bus cycle of these commands. The command code written in the first bus cycle becomes invalid.

Table 20.8 Pin Descriptions (Flash Memory Standard Serial I/O Mode)

Pin	Name	I/O	Description
Vcc, Vss	Power input		Apply the voltage guaranteed for Program and Erase to Vcc pin and 0 V to Vss pin.
CNVss	CNVs	I	Connect to Vcc pin.
RESET	Reset input	I	Reset input pin. While RESET pin is "L", wait for td(ROC).
XIN	Clock input	I	Connect a ceramic resonator or crystal oscillator between XIN and XOUT pins. To input an externally generated clock, input it to XIN pin and open XOUT pin.
XOUT	Clock output	O	
AVcc, AVss	Analog power supply input		Connect AVss to Vss and AVcc to Vcc, respectively.
VREF	Reference voltage input	I	Enter the reference voltage for AD conversion.
P00 to P07	Input port P0	I	Input "H" or "L" signal or leave open.
P10 to P15, P17	Input port P1	I	Input "H" or "L" signal or leave open.
P16	Input port P1	I	Connect this pin to Vcc while RESET pin is "L". (2)
P20 to P27	Input port P2	I	Input "H" or "L" level signal or leave open.
P30 to P37	Input port P3	I	Input "H" or "L" level signal or leave open.
P60 to P63	Input port P6	I	Input "H" or "L" level signal or leave open.
P64	BUSY output	O	Standard serial I/O mode 1: BUSY signal output pin Standard serial I/O mode 2: Monitor signal output pin for boot program operation check
P65	SCLK input	I	Standard serial I/O mode 1: Serial clock input pin Standard serial I/O mode 2: Input "L".
P66	RxD input	I	Serial data input pin
P67	TxD output	O	Serial data output pin (1)
P70 to P77	Input port P7	I	Input "H" or "L" signal or leave open.
P80 to P84, P87	Input port P8	I	Input "H" or "L" signal or leave open.
P85	RP input	I	Connect this pin to Vss while RESET pin is "L". (2)
P86	CE input	I	Connect this pin to Vcc while RESET pin is "L". (2)
P90 to P92, P95 to P97	Input port P9	I	Input "H" or "L" signal or leave open.
P93	Input port P93	Normal-ver.	I/O "H" signal is output for specific time. Input "H" signal or leave open.
		T-ver./V-ver.	I Input "H" or "L" signal or leave open.
P100 to P107	Input port P10	I	Input "H" or "L" signal or leave open.

NOTES:

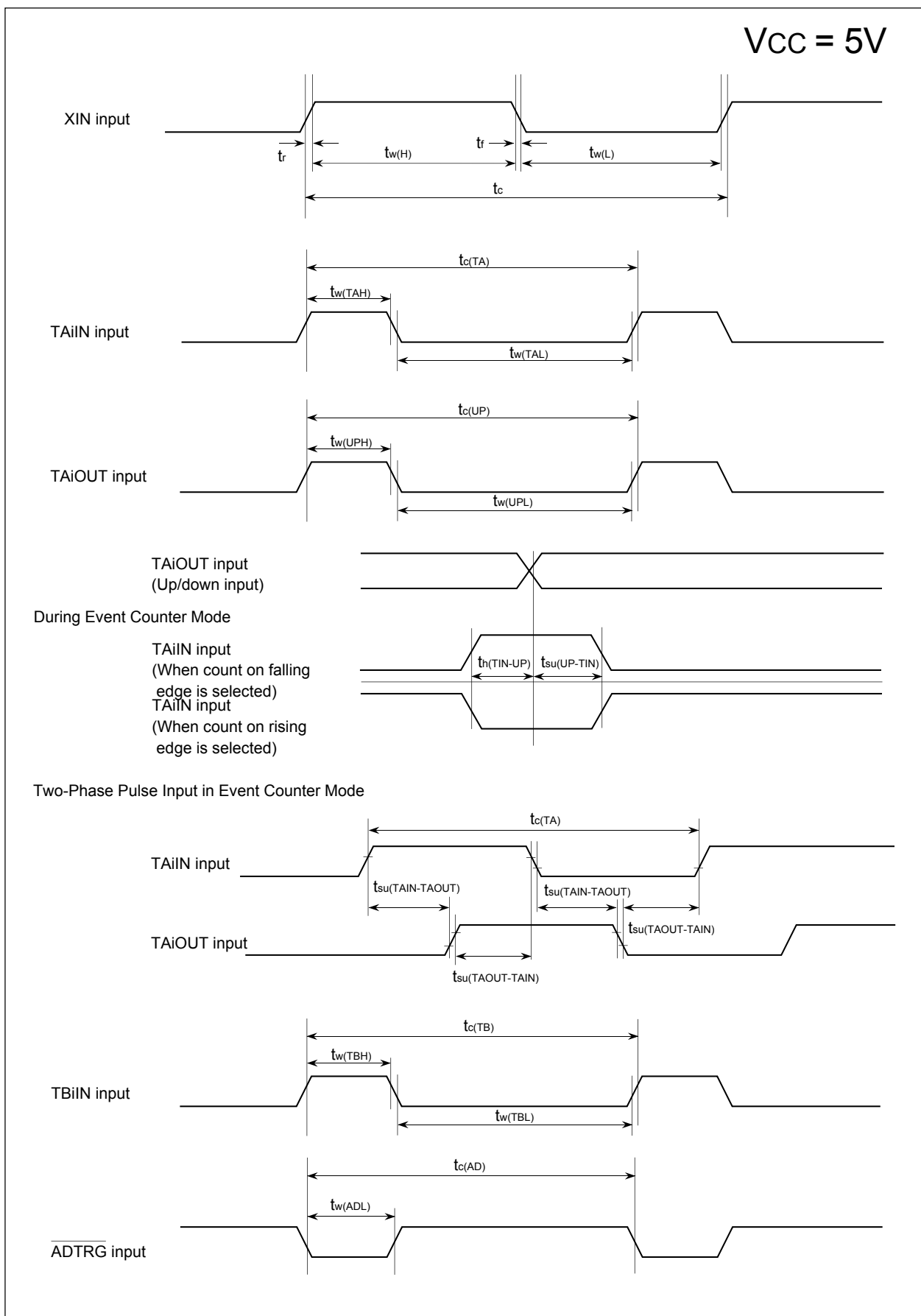
- When using standard serial I/O mode 1, to input "H" to the TxD pin is necessary while the RESET pin is held "L". Therefore, connect this pin to Vcc via a resistor. Adjust the pull-up resistor value on a system not to affect a data transfer after reset, because this pin changes to a data-output pin
- Set the following, either or both.
 - Connect the CE pin to Vcc.
 - Connect the RP pin to VSS and P16 pin to Vcc.

20.10 Parallel I/O Mode

In parallel input/output mode, the user ROM can be rewritten by a parallel programmer supporting the M16C/29 group. Contact your parallel programmer manufacturer for more information on the parallel programmer. Refer to the user's manual included with your parallel programmer for instructions.

20.10.1 ROM Code Protect Function

The ROM code protect function prevents the flash memory from being read or rewritten. (Refer to **20.3 Functions To Prevent Flash Memory from Rewriting**).

**Figure 21.1 Timing Diagram (1)**

$$V_{CC} = 3V$$

Timing Requirements

($V_{CC} = 3V$, $V_{SS} = 0V$, at $T_{opr} = -40$ to $85^{\circ}C$ unless otherwise specified)

Table 21.77 Multi-master I²C bus Line

Symbol	Parameter	Standard clock mode		High-speed clock mode		Unit
		Min.	Max.	Min.	Max.	
tBUF	Bus free time	4.7		1.3		μs
tHD;STA	The hold time in start condition	4.0		0.6		μs
tLOW	The hold time in SCL clock 0 status	4.7		1.3		μs
tR	SCL, SDA signals' rising time		1000	20+0.1Cb	300	ns
tHD;DAT	Data hold time	0		0	0.9	μs
tHIGH	The hold time in SCL clock 1 status	4.0		0.6		μs
tF	SCL, SDA signals' falling time		300	20+0.1Cb	300	ns
tsu;DAT	Data setup time	250		100		ns
tsu;STA	The setup time in restart condition	4.7		0.6		μs
tsu;STO	Stop condition setup time	4.0		0.6		μs

$$V_{CC} = 5V$$

Timing Requirements(V_{CC}=5V, V_{SS}=0V, at T_{op}=-40 to 125°C unless otherwise specified)**Table 21.93 Timer B Input (Counter Input in Event Counter Mode)**

Symbol	Parameter	Standard		Unit
		Min.	Max.	
t _{c(TB)}	TBiIN Input Cycle Time (counted on one edge)	100		ns
t _{w(TBH)}	TBiIN Input High ("H") Width (counted on one edge)	40		ns
t _{w(TBL)}	TBiIN Input Low ("L") Width (counted on one edge)	40		ns
t _{c(TB)}	TBiIN Input Cycle Time (counted on both edges)	200		ns
t _{w(TBH)}	TBiIN Input High ("H") Width (counted on both edges)	80		ns
t _{w(TBL)}	TBiIN Input Low ("L") Width (counted on both edges)	80		ns

Table 21.94 Timer B Input (Pulse Period Measurement Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
t _{c(TB)}	TBiIN Input Cycle Time	400		ns
t _{w(TBH)}	TBiIN Input High ("H") Width	200		ns
t _{w(TBL)}	TBiIN Input Low ("L") Width	200		ns

Table 21.95 Timer B Input (Pulse Width Measurement Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
t _{c(TB)}	TBiIN Input Cycle Time	400		ns
t _{w(TBH)}	TBiIN Input High ("H") Width	200		ns
t _{w(TBL)}	TBiIN Input Low ("L") Width	200		ns

Table 21.96 A/D Trigger Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
t _{c(AD)}	AD _{TRG} Input Cycle Time (required for trigger)	1000		ns
t _{w(ADL)}	AD _{TRG} Input Low ("L") Width	125		ns

Table 21.97 Serial I/O

Symbol	Parameter	Standard		Unit
		Min.	Max.	
t _{c(CK)}	CLKi Input Cycle Time	200		ns
t _{w(CKH)}	CLKi Input High ("H") Width	100		ns
t _{w(CKL)}	CLKi Input Low ("L") Width	100		ns
t _{d(C-Q)}	TxDi Output Delay Time		80	ns
t _{h(C-Q)}	TxDi Hold Time	0		ns
t _{su(D-C)}	RxDi Input Setup Time	70		ns
t _{h(C-Q)}	RxDi Input Hold Time	90		ns

Table 21.98 External Interrupt INTi Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
t _{w(INH)}	INTi Input High ("H") Width	250		ns
t _{w(INL)}	INTi Input Low ("L") Width	250		ns

22.11.2 CAN Transceiver in Boot Mode

When programming the flash memory in boot mode via CAN bus, the operation mode of CAN transceiver should be set to “high-speed mode” or “normal operation mode”. If the operation mode is controlled by the MCU, CAN transceiver must be set the operation mode to “high-speed mode” or “normal operation mode” before programming the flash memory by changing the switch etc. **Tables 22.3 and 22.4** show pin connections of CAN transceiver.

Table 22.3 Pin Connections of CAN Transceiver (In case of PCA82C250: Philips product)

	Standby mode	High-speed mode
Rs pin (Note 1)	“H”	“L”
CAN communication	impossible	possible
Connection		

Note 1: The pin which controls the operation mode of CAN transceiver.

Note 2: Connect to enabled port to control CAN transceiver.

Table 22.4 Pin Connections of CAN Transceiver (In case of PCA82C252: Philips product)

	Sleep mode	Normal operation mode
STB pin (Note 1)	“L”	“H”
EN pin (Note 1)	“L”	“H”
CAN communication	impossible	possible
Connection		

Note 1: The pin which controls the operation mode of CAN transceiver.

Note 2: Connect to enabled port to control CAN transceiver.

22.14 Mask ROM Version

22.14.1 Internal ROM Area

In the masked ROM version, do not write to internal ROM area. Writing to the area may increase power consumption.

22.14.2 Reserved Bit

The b3 to b0 in addresses 0FFFFFF₁₆ are reserved bits. Set these bits to 1112.

Appendix 2. Functional Comparison

Appendix 2.1 Difference between M16C/28 Group and M16C/29 Group (Normal-ver.) ⁽¹⁾

Item	Description	M16C/28(Normal-ver.)	M16C/29(Normal-ver.)
Clock Generation Circuit	Clock output function (function of b1 to b0 bits in the CM0 register)	Not available (reserved bit)	Available (clock output function select bit)
Protection	Function of the PRC0 bit	Enable to set the CM0, CM1, CM2, POOCR, PLC0 and PCLKR registers	Enable to set the CM0, CM1, CM2, POOCR, PLC0, PCLKR and CCLKR registers
Interrupt	The IFSR20 bit setting in the IFSR2A register	Set to 1	Set to 0
	The b1 bit in the IFSR2A register	Not available (reseved bit)	Interrupt cause switching bit (0: A/D conversion, 1:key input)
	The b2 bit in the IFSR2A register	Not available (reseved bit)	Interrupt cause switching bit (0: CAN0 wake-up/ error)
	Interrupt cause in the Interrupt number 13	Key input interrupt	CAN0 error
	Interrupt cause in the Interrupt number 14	Key input interrupt	A/D, key input interrupt
Three-phase Motor Control Timer	Three-phase port switching function (function of 0358 ₁₆)	Not available (reserved register)	Available (port function select register)
A/D	Number of A/D input pin	24 channels (excluding AN30 to AN32)	27 channels (including AN30 to AN32)
	Delayed trigger mode 0	Not available in the 1st chip version and chip version A	Available
	Delayed trigger mode 1	Not available in the 1st chip version and chip version A	Available
CAN module	compatible to 2.0B	Not available (all related registers are reserved registers)	Available (1 channel)
CRC Calculation	Available (compatible to CRC-CCITT and CRC-16 methods)	Not available (all related registers are reserved registers)	Available (1 circuit)
Pin Function	2 pins (80-pin/85-pin package), 62 pins (64-pin package)	P93/AN24	P93/AN24/CTX
	3 pins (80-pin/85-pin package), 64 pins (64-pin package)	P92/TB2IN	P92/AN32/TB2IN/CRX
	4 pins (80-pin/85-pin package), 1 pin (64-pin package)	P91/TB1IN	P91/AN31/TB1IN
	5 pins (80-pin/85-pin package), 2 pins (64-pin package)	P90/TB0IN	P90/AN30/TB0IN/CLKOUT
Flash Memory	P93 in standard serial I/O mode	I (other than 128 Kbyte version) I/O (128 Kbyte version)	CTX output

I: Input O: Output I/O: Input and output

NOTE:

1. Since the M16C/28 group uses the common emulator used in the M16C/29 group, all the functions are available for M16C/28. When evaluating M16C/28 group, do not access to the SFR which is not built-in the M16C/28 group. Refere to hardware manual for details and electrical characteristics.